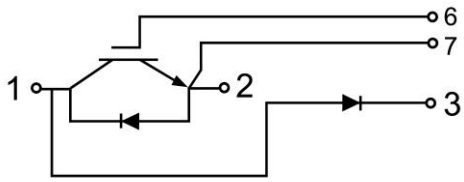
GT200CU170T2VH

Preliminary Data

IGBT Module

Features：



- Field Stop Trench Gate IGBT
- Short Circuit Rated>10μs
- Low Saturation Voltage
- Low Switching Loss
- 100% RBSOA Tested(2×Ic)
- Low Stray Inductance
- Lead Free, Compliant with RoHS Requirement

Applications：

- Industrial Inverters
- Motor Drives
- UPS Systems

IGBT, Chopper

Maximum Rated Values (T_C=25℃ unless otherwise specified)

V_{CES}	Collector-Emitter Blocking Voltage		1700	V
V_{GES}	Gate-Emitter Voltage		±20	V
I_C	Continuous Collector Current	T_C=100℃	200	A
		T_C=25℃	400	A
I_{CM}	Peak Collector Current Repetitive	t_P=1ms	400	A
P_D	Maximum Power Dissipation (IGBT)	T_C=25℃ T_{Jmax}=175℃	1449	W

Electrical Characteristics of IGBT (T_C=25℃ unless otherwise specified)

Static Characteristics

Symbol	Description	Conditions		Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	I_C=8mA, V_{CE}=V_{GE}		5.2	6.1	6.8	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	I_C=200A, V_{GE}=15V	T_J=25℃		1.75	2.10	V
			T_J=125℃		2.05		V
			T_J=150℃		2.10		V
I_{CES}	Collector-Emitter Leakage Current	V_{GE}=0V, V_{CE}=V_{CES}, T_J=25℃				1	mA
I_{GES}	Gate-Emitter Leakage Current	V_{GE}=±20V, V_{CE}=0V, T_J=25℃				±200	nA
C_{ies}	Input Capacitance	V_{CE}=25V, V_{GE}=0V, f=100kHz			41.02		nF
C_{oes}	Output Capacitance				1.12		nF
C_{res}	Reveres Transfer Capacitance				0.22		nF

Switching Characteristics

$t_{d(on)}$	Turn-on Delay Time	V_{CC}=900V, I_C=200A, R_{Gon}=3.3Ω, V_{GE}=±15V, Inductive Load	T_J=25℃		507		ns
			T_J=125℃		510		
			T_J=150℃		515		
t_r	Rise Time		T_J=25℃		77		ns
			T_J=125℃		85		
			T_J=150℃		87		
$t_{d(off)}$	Turn-off Delay Time	V_{CC}=900V, I_C=200A, R_{Goff}=3.3Ω, V_{GE}=±15V, Inductive Load	T_J=25℃		380		ns
			T_J=125℃		400		
			T_J=150℃		413		
t_f	Fall Time		T_J=25℃		570		ns
			T_J=125℃		690		
			T_J=150℃		820		
E_{on}	Turn-on Switching Loss	V_{CC}=900V, I_C=200A, R_{Gon}=3.3Ω, V_{GE}=±15V, di/dt=1960A/μs(T_J=150℃), Inductive Load	T_J=25℃		22.2		mJ
			T_J=125℃		31.2		
			T_J=150℃		33.6		

E_{off}	Turn-off Switching Loss	V_{CC}=900V, I_C=200A, R_{Goff}=3.3Ω, V_{GE}=±15V, du/dt=6340V/μs(T_J=150℃), Inductive Load	T_J=25℃		33.0		mJ
			T_J=125℃		42.8		
			T_J=150℃		47.0		
Q_g	Total Gate Charge	V_{GE}=+15V…-15V	T_J=25℃		2077		nC
$R_{G(int)}$	Internal Gate Resistor		T_J=25℃		0.5		Ω
I_{SC}	V_{CC}=900V, V_{GE}=+/-15V, tp=10us, T_J=150℃				900		A
$R_{\theta JC}$	Thermal Resistance: Junction-to-Case (per IGBT)					0.10	℃/W

Diode, Chopper

Maximum Rated Values (T_C=25℃ unless otherwise specified)

V_{RRM}	Repetitive Peak Reverse Voltage	T_J=25℃	1700	V
I_F	Diode Continuous Forward Current	T_C=100℃	200	A
I_{FM}	Peak Diode Current Repetitive	t_P=1ms	400	A

Electrical Characteristics of Diode (T_C=25℃ unless otherwise specified)

Symbol	Description	Conditions		Min.	Typ.	Max.	Units
V_{FM}	Forward Voltage	I_F=200A	T_J=25℃		2.00		V
			T_J=125℃		2.20		
			T_J=150℃		2.15		
t_{rr}	Reverse Recovery Time	I_F=200A, -diF/dt=2965A/μs(T_J=150℃), V_R=900V, V_{GE}=-15V	T_J=25℃		298		ns
			T_J=125℃		513		
			T_J=150℃		601		
I_{rr}	Peak Reverse Recovery Current		T_J=25℃		216		A
			T_J=125℃		276		
			T_J=150℃		294		
Q_{rr}	Reverse Recovery Charge		T_J=25℃		26		μC
			T_J=125℃		50		
			T_J=150℃		58		

E_{rec}	Reverse Recovery Energy	I_F=200A, -diF/dt=2965A/μs(T_J=150℃), V_R=900V, V_{GE}=-15V	T_J=25℃		15.0		mJ
			T_J=125℃		30.9		
			T_J=150℃		36.8		
$R_{\theta JC}$	Thermal Resistance: Junction-to-Case (per Diode)					0.19	℃/W

Diode, Reverse

Maximum Rated Values of Diode (T_C=25℃ unless otherwise specified)

V_{RRM}	Repetitive Peak Reverse Voltage	T_J=25℃	1700	V
I_F	Diode Continuous Forward Current	T_C=100℃	150	A
I_{FM}	Peak FWD Current Repetitive	t_P=1ms	300	A

Electrical Characteristics of Diode (T_C=25℃ unless otherwise specified)

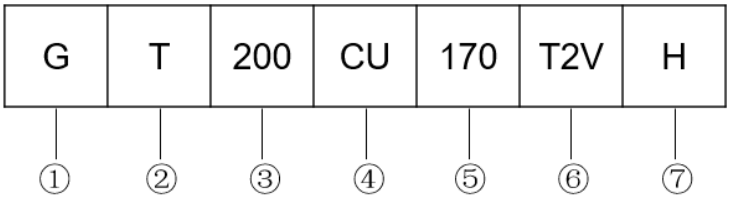
Symbol	Description	Conditions		Min.	Typ.	Max.	Units
V_{FM}	Forward Voltage	I_F=150A	T_J=25℃		2.00		V
			T_J=125℃		2.25		
			T_J=150℃		2.20		
t_{rr}	Reverse Recovery Time	I_F=150A, -diF/dt=2574A/μs(T_J=150℃), V_R=900V, V_{GE}=-15V	T_J=25℃		452		ns
			T_J=125℃		622		
			T_J=150℃		659		
I_{rr}	Peak Reverse Recovery Current		T_J=25℃		128		A
			T_J=125℃		153		
			T_J=150℃		163		
Q_{rr}	Reverse Recovery Charge		T_J=25℃		19		μC
			T_J=125℃		30		
			T_J=150℃		33		
E_{rec}	Reverse Recovery Energy		T_J=25℃		11.0		mJ
			T_J=125℃		19.9		
			T_J=150℃		21.0		
$R_{\theta JC}$	Thermal Resistance: Junction-to-Case (per Diode)					0.28	℃/W

Module

Symbol	Description	Conditions	Min.	Typ.	Max.	Units
V_{iso}	Isolation Voltage (All Terminals Shorted)	f=50Hz, 1minute		2500		V
T_J	Maximum Junction Temperature				175	℃
T_{JOP}	Maximum Operating Junction Temperature Range		-40		+150	℃
T_{stg}	Storage Temperature		-40		+125	℃
CTI	Comparative Tracking Index			200		
$R_{\theta CS}$	Case-to-Sink Thermally (Conductive Grease Applied)				0.03	℃/W
T	Power Terminals Screw:M6		3.0		5.0	N·m
T	Mounting Screw:M6		3.0		6.0	N·m
G	Weight			300		g

Ordering Information Table

Device code



① - IGBT Modules
② - Trench, Low Switching Losses IGBT
③ - Rated Current (200=200A)
④ - Circuit Configuration: Chopper, CU(Diode on High Side)
⑤ - Rated Voltage (170=1700V)
⑥ - Package Type
⑦ - Test Level (Pass the Important Reliability Test-Industrial Grade)

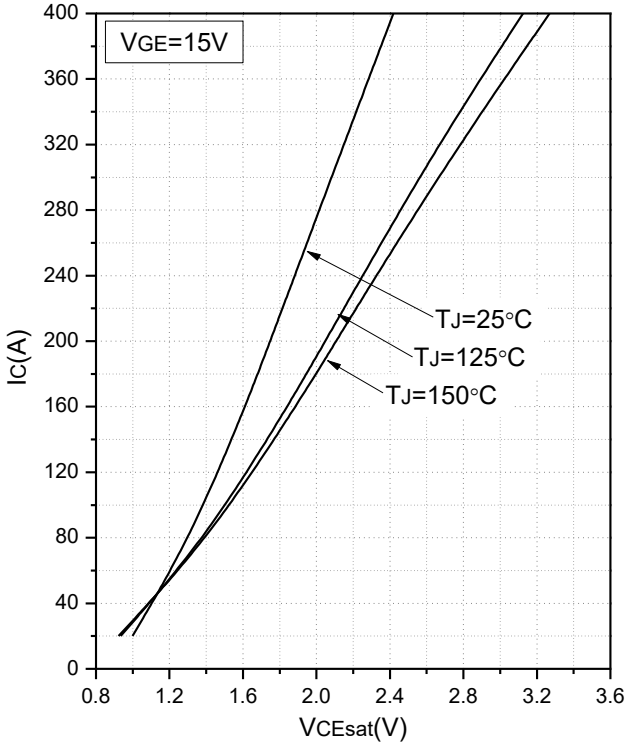


Fig.1 Typical Saturation Voltage Characteristics

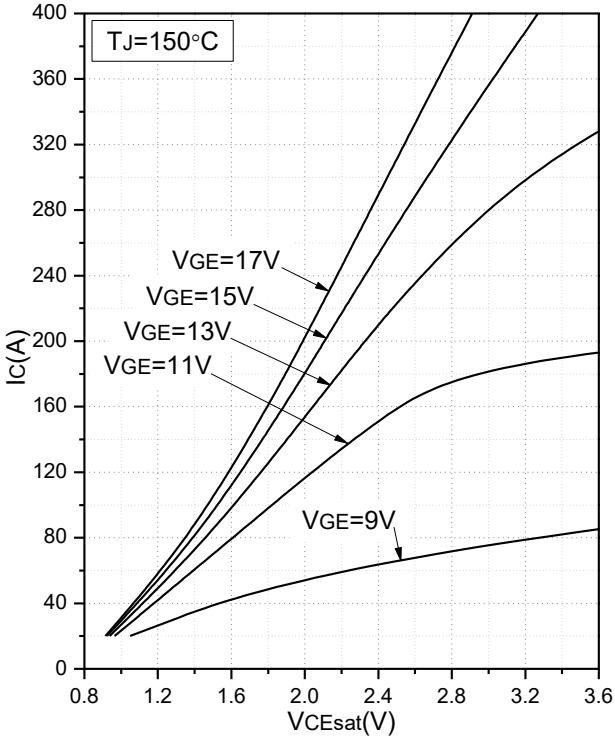


Fig.2 Typical Output Characteristics

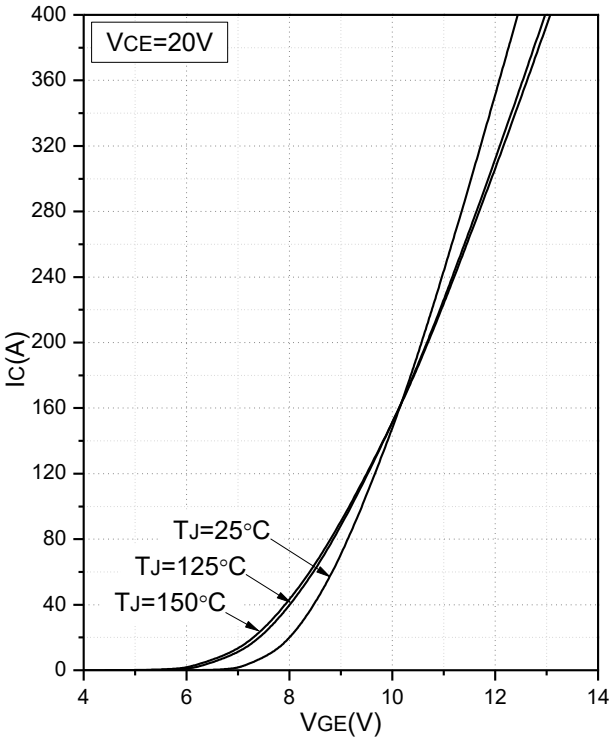


Fig.3 Transfer Characteristics

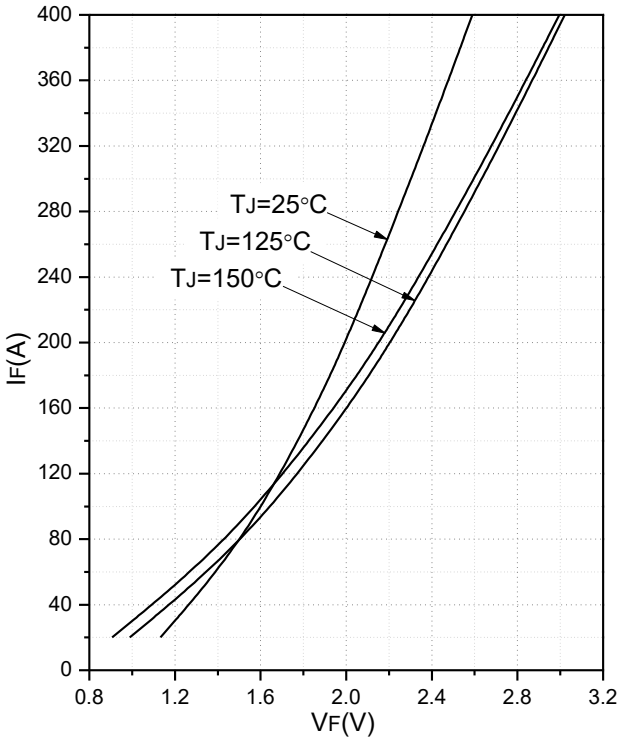


Fig.4 Forward Characteristics of Diode

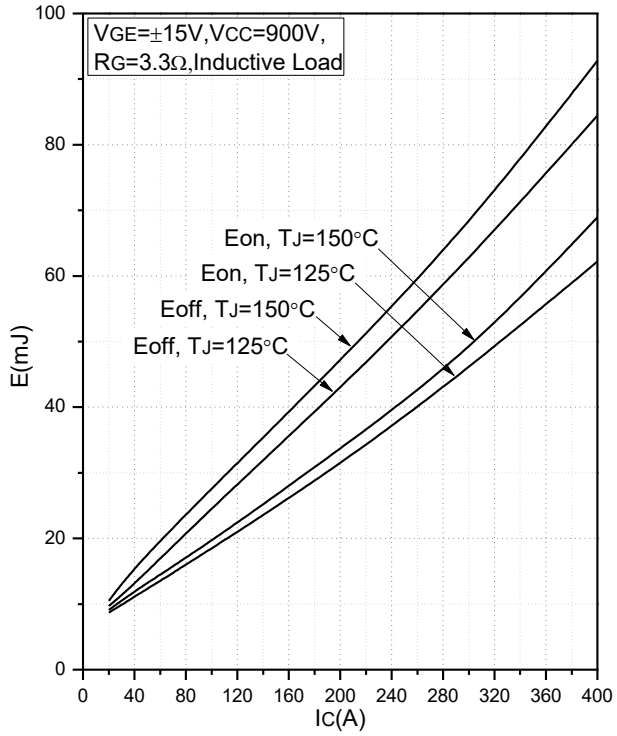


Fig.5 Typical Switching Loss vs. Collector Current

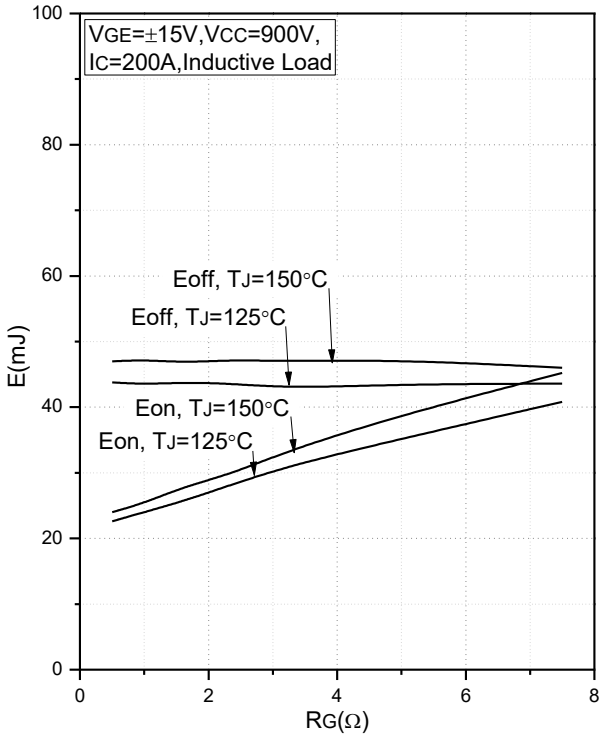


Fig.6 Typical Switching Loss vs. Gate Resistance

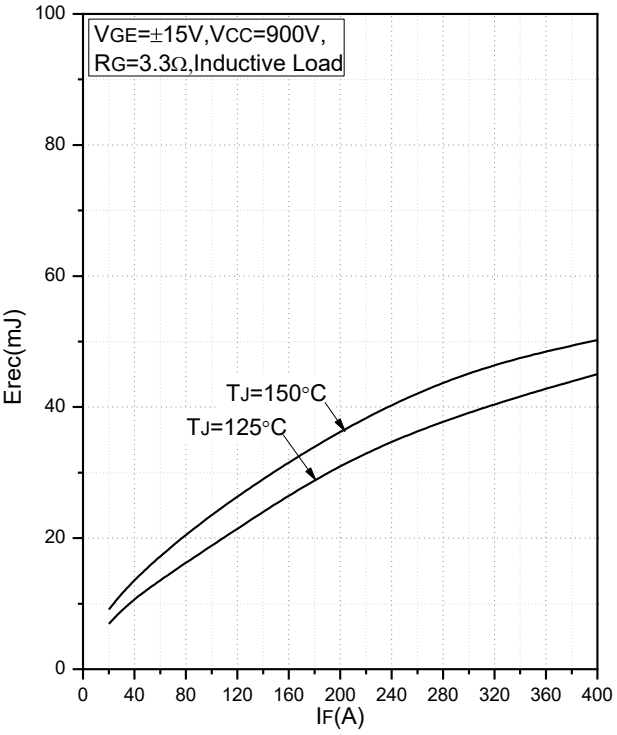


Fig.7 Typical Switching Loss vs. Forward Current

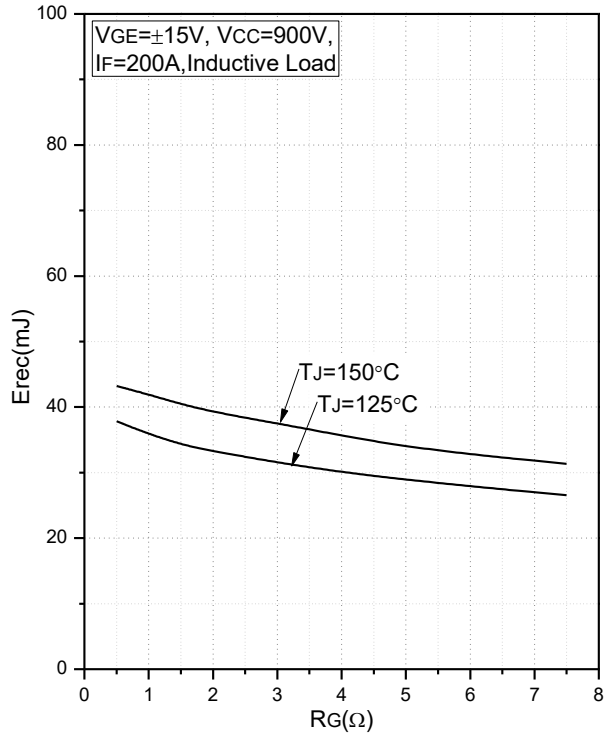


Fig.8 Typical Switching Loss vs. Gate Resistance

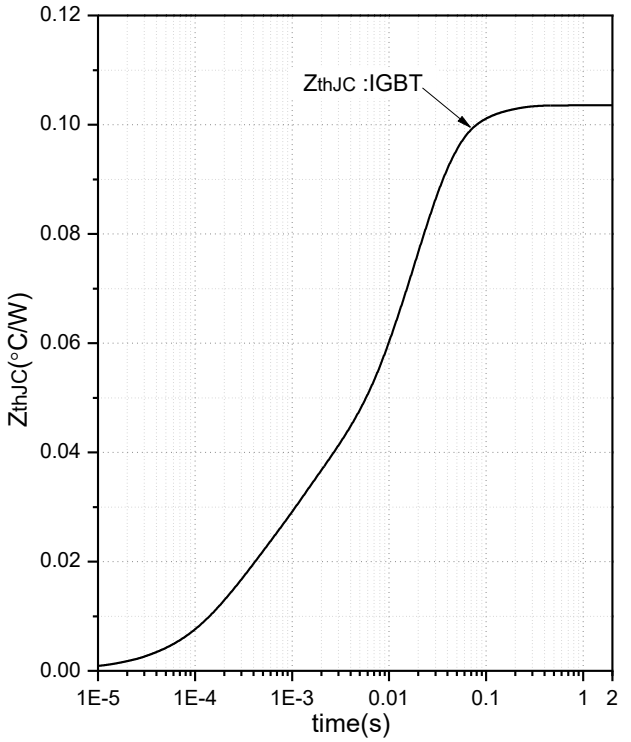


Fig.9 Transient Thermal Impedance (Chopper-IGBT)

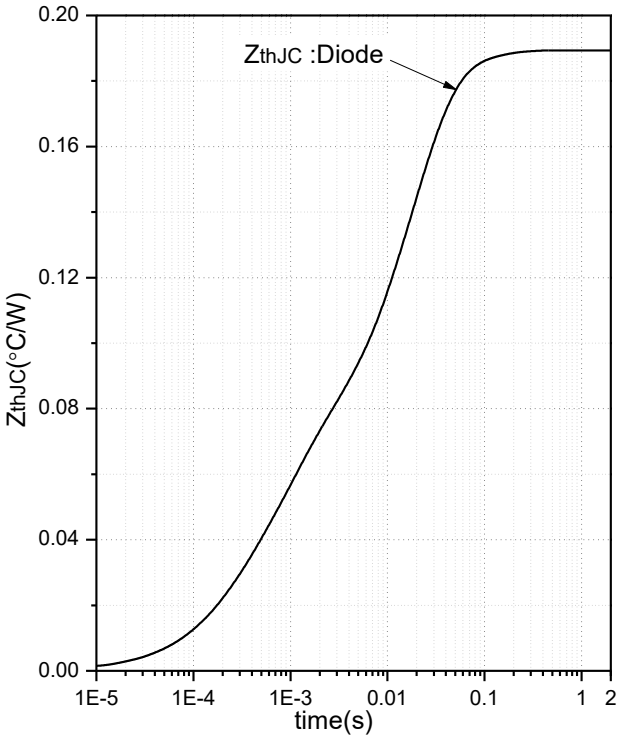


Fig.10 Transient Thermal Impedance (Chopper-Diode)

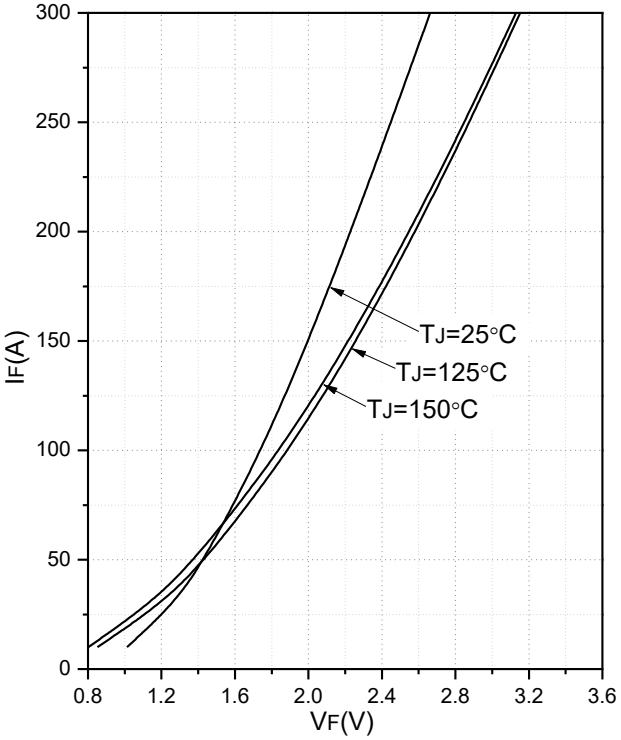


Fig.11 Forward Characteristics of Diode (Reverse)

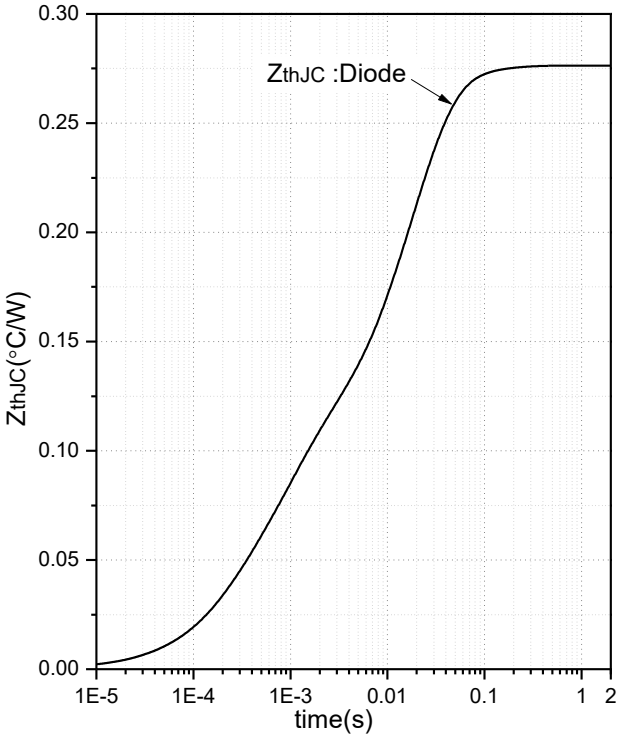


Fig.12 Transient Thermal Impedance (Reverse Diode)

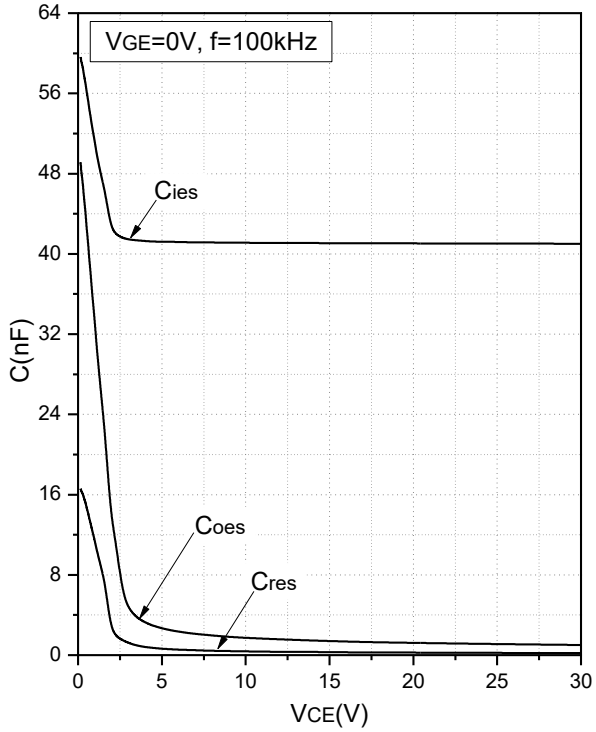


Fig.13 Capacitance Characteristics

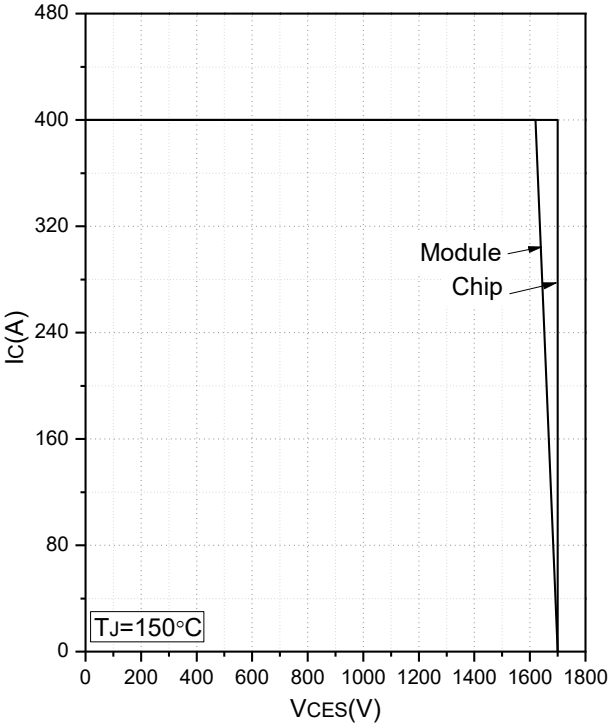
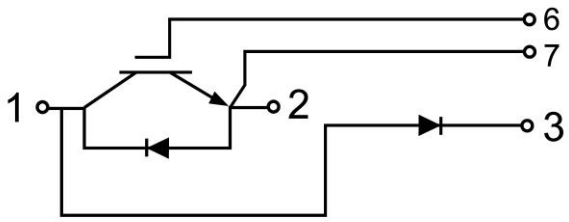
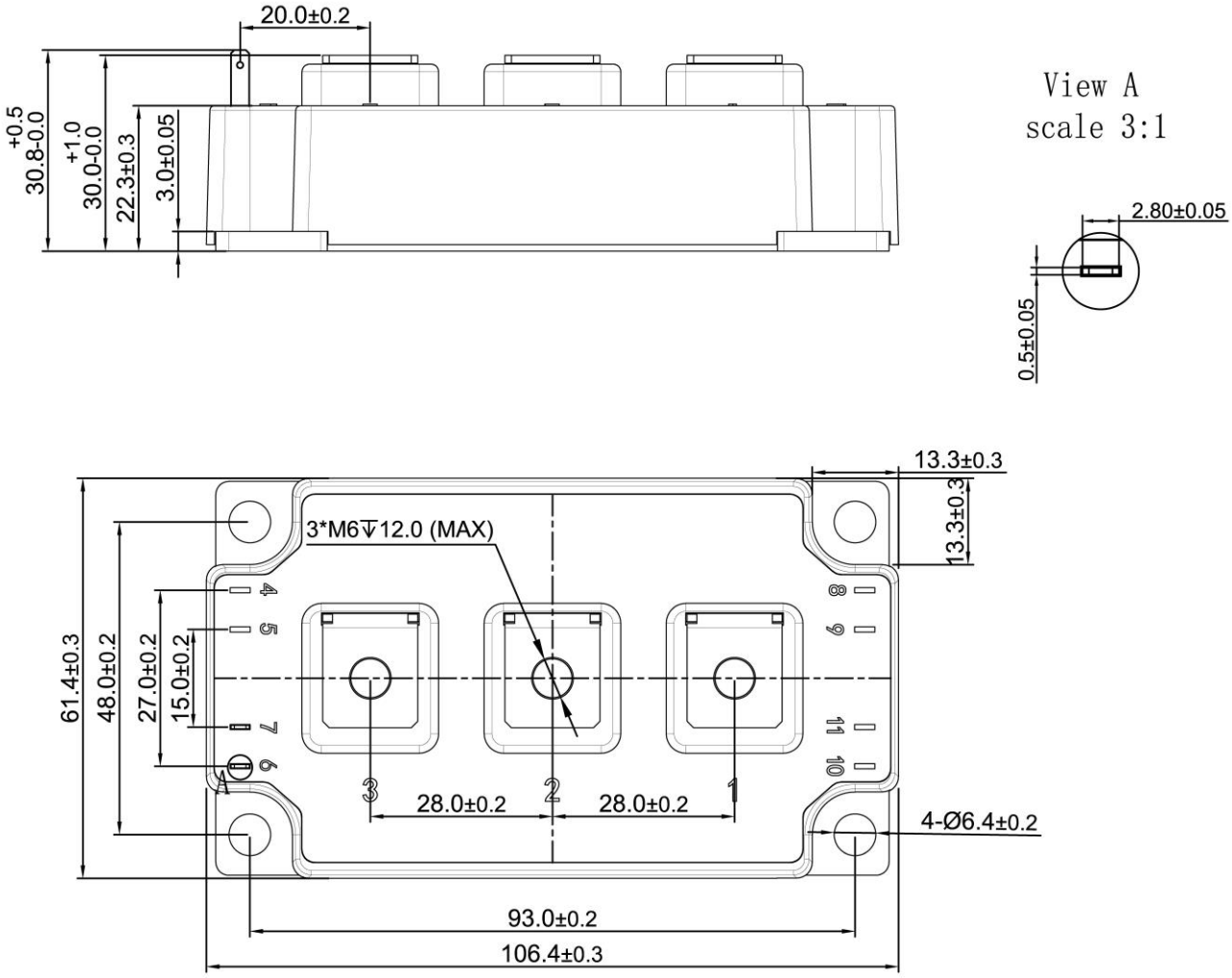


Fig.14 Reverse Bias Safe Operation Area (RBSOA)

Internal Circuit:



Package Outline (Unit: mm):



Revision	Notes
01	Initial release

Announcement

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